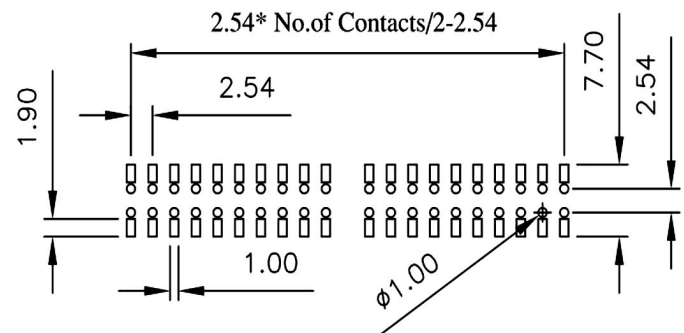


Current Rating: 3 Amps  
 Insulator Resistance: 5000 Megohms min  
 Contact Resistance: 20 m ohms max  
 Dielectric Withstanding: 1000 V AC  
 Operating Temperature: - 40° ~ +105° C  
 Max Processing Temp: 230° C for 60 seconds  
 260° C for 10 seconds

Contact Material: Phosphor Bronze  
 Insulator Material: High Temperature Plastic, UL 94V-0

Finish: Tin, Gold Plated  
 Standard: Gold Flash all over

Recommended P.C. Board  
 SMD Layout



06~20 pin : 0.10 mm MAX.  
 22~50 pin : 0.20 mm MAX.  
 52~80 pin : 0.30 mm MAX.

RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准	SCALE 比例	TOLERANCE 容許公差	PART NAME 品名
DWG. 製圖	UNIT 單位	SIZE 紙張尺寸	2.54mm FEMALE HEADER DUAL ROWS H=7.1mm SMT TYPE 2X20P GOLD FLASH PLATING WITH BUMP WITHOUT LOCATING PEG
DATE 製表日	PAGE 張數	REV. 版次	ROHS
2016/04/11	1 OF 1	A	PART NO. 料號
			C2831-XXBDGHNXR